

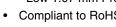


# P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)			
- 20	0.0108 at V <sub>GS</sub> = - 4.5 V	- 15.3			
	0.015 at V <sub>GS</sub> = - 2.5 V	- 13.0			
	0.020 at V <sub>GS</sub> = - 1.8 V	- 11.2			

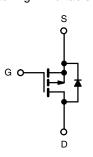
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET: 1.8 V Rated
- Ultra Low On-Resistance for Increased **Battery Life**
- New PowerPAK<sup>®</sup> Package
  - Low Thermal Resistance,  $R_{thJC}$
  - Low 1.07 mm Profile
- Compliant to RoHS Directive 2002/95/EC



**APPLICATIONS** 

· Load/Power Switching in Portable Devices



P-Channel MOSFET

# PowerPAK 1212-8

Ordering Information: Si7107DN-T1-E3 (Lead (Pb)-free)

**Bottom View** 

Si7107DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 20		V
Gate-Source Voltage		$V_{GS}$	± 8		
Out 1 - 150 00 3	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 15.3	- 9.8	^
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		- 12.2	- 7.8	
Pulsed Drain Current		I <sub>DM</sub>	- 40		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 3.2	- 1.3	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.8	1.5	W
	T <sub>A</sub> = 70 °C		2.4	1.0	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Soldering Recommendations (Peak Temperature)b, c			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariano de Location de Ambienda	t ≤ 10 s	- R <sub>thJA</sub>	24	33	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		65	81	
Maximum Junction-to-Case	Steady State	$R_{thJC}$	1.9	2.4	

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

# Vishay Siliconix



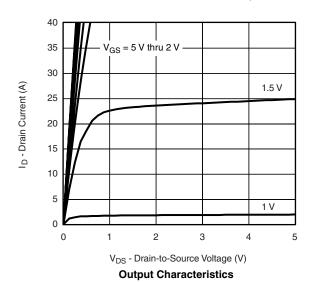
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -450 \mu A$	- 0.4		- 1.0	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1			
		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 40			Α		
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 15.3 A		0.0090	0.0108	0.0108 0.015 Ω 0.020		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 13 A		0.0125	0.015			
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 5 A		0.0167	0.020			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 15.3 A		58		S		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 3.2 A, V <sub>GS</sub> = 0 V		- 0.7	- 1.2	V		
Dynamic <sup>b</sup>								
Total Gate Charge	Qg			34	44			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -15.3 \text{ A}$		4.6		nC		
Gate-Drain Charge	$Q_{gd}$			9.2				
Gate Resistance	$R_g$	f = 1 MHz		8		Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			27	40			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 10 $\Omega$		55	85			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 1 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 6 $\Omega$		270	400	ns		
Fall Time	t <sub>f</sub>			160	240			
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 3.2 A, dl/dt = 100 A/μs		110	165			

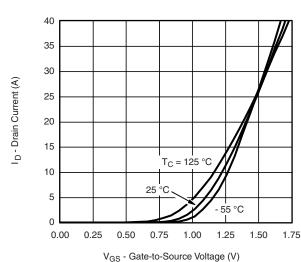
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





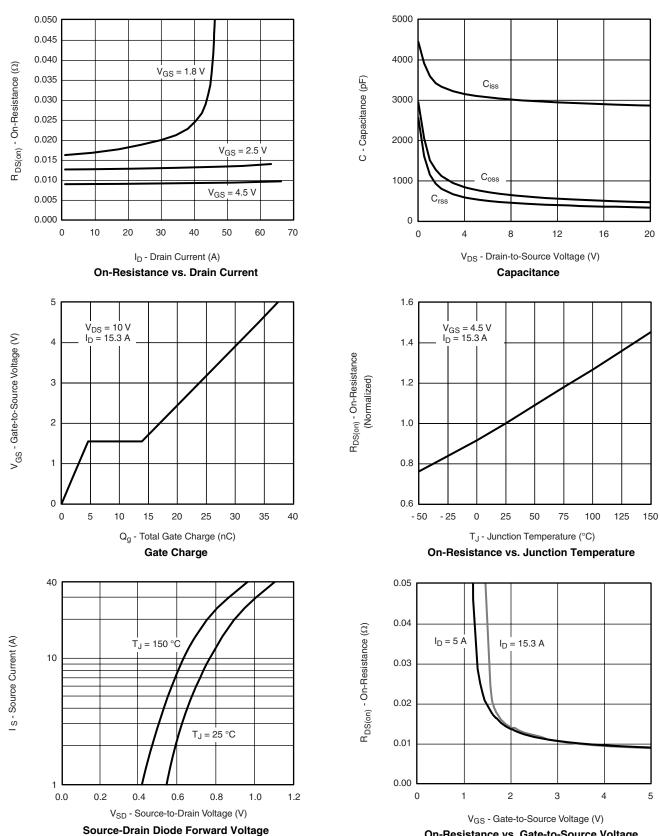
**Transfer Characteristics** 







## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

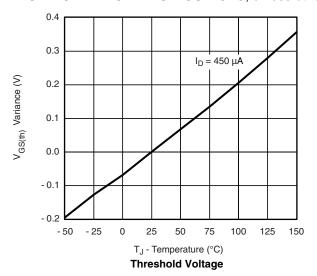


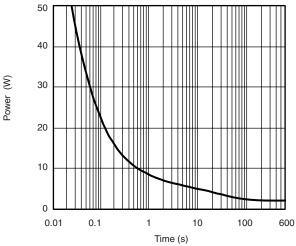
On-Resistance vs. Gate-to-Source Voltage

# Vishay Siliconix

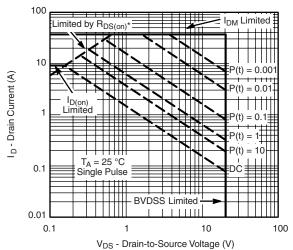
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



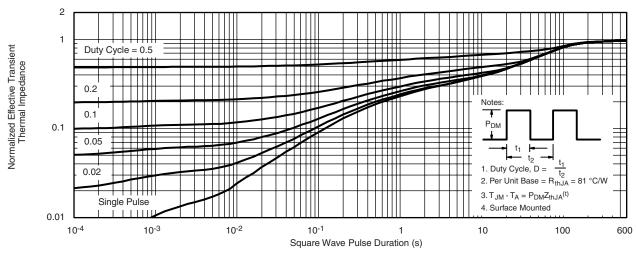


Single Pulse Power, Junction-to-Ambient



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

#### Safe Operating Area

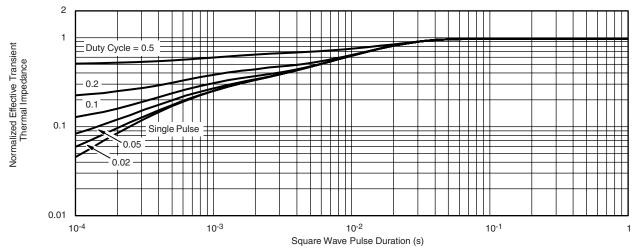


Normalized Thermal Transient Impedance, Junction-to-Ambient





# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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